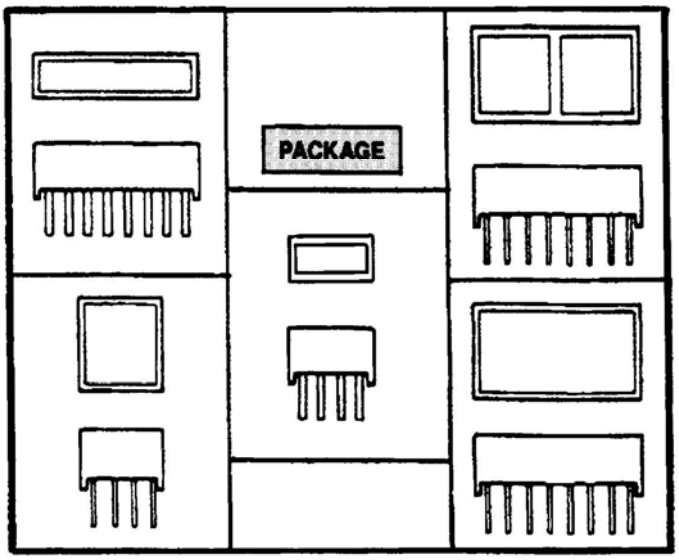
EVERLIGHT

LED LIGHT BARS

HIGH EFFICIENCY RED **HLMP-2300/2600 SERIES**
YELLOW **HLMP-2400/2700 SERIES**
HIGH EFFICIENCY GREEN **HLMP-2500/2800 SERIES**



DESCRIPTION

These LED Light Bar series are bright, large emitting area, rectangular devices that are designed for backlighting legend/message annunciators.

These devices are offered in single-in-line and dual-in-line packages that contain single or segmented light-emitting area. Each package style is offered in High Efficiency Red, Yellow, or Green emission color.

FEATURES

- Large area, uniform, bright light-emitting surfaces
- Select from six package styles
- Choice of three colors
- Categorized for intensity and color
- X-Y stackable
- Easily driven with I.C.s
- Alternate source for popular backlighting components

MODEL NUMBERS

PART NO.	COLOR	DESCRIPTION		PACKAGE	PIN OUT
HLMP-2300 HLMP-2400 HLMP-2500	High Efficiency Red Yellow High Efficiency Green	2 LED Single-in-line 0.35 in.×0.15 in. Area		A	A
HLMP-2350 HLMP-2450 HLMP-2550	High Efficiency Red Yellow High Efficiency Green	4 LED Single-in-line 0.75 in.×0.15 in. Area		B	B
HLMP-2655 HLMP-2755 HLMP-2855	High Efficiency Red Yellow High Efficiency Green	4 LED Dual-in-line 0.35 in.×0.35 in. Area		C	C
HLMP-2670 HLMP-2770 HLMP-2870	High Efficiency Red Yellow High Efficiency Green	Dual 0.35 in.×0.35 in. Area Dual-in-line package		D	D
HLMP-2685 HLMP-2785 HLMP-2885	High Efficiency Red Yellow High Efficiency Green	8 LED 0.35 in.×0.75 in. Area Dual-in-line package		E	D

ELECTRO-OPTICAL CHARACTERISTICS (T_A=25°C)
HIGH EFFICIENCY RED

PARAMETER		SYMBOL	HLMP -2300	-2350	-2655	-2670	-2685	UNIT	TEST CONDITIONS
Luminous Intensity	min.	I_V	6.0	13	13	13	22	mcd	I_F=20 mA
	typ.		23	45	43	45	80	mcd	I_F=20 mA
	typ.		30	50	50	50	100	mcd	I_F=60 mA pK, 1:3 D.F.
Forward voltage	max.	V_F	2.6	2.6	2.6	2.6	2.6	V	I_F=20 mA
	typ.		2.0	2.0	2.0	2.0	2.0		
Peak wavelength	typ.	λ_p	630	630	630	630	630	nm	
Dominant wavelength	typ.	λ_d	626	626	626	626	626	nm	
Capacitance	typ.	C	45	45	45	45	45	pF	V_F=0, f=1 MHz
Reverse voltage	min.	V_R	6	6	6	6	6	V	I_R=100 μA
Thermal resistance	typ.	θ_{JL}	150	150	150	150	150	°C/W/ LED chip	

ELECTRO-OPTICAL CHARACTERISTICS (T_A=25°C)
YELLOW

PARAMETER		SYMBOL	HLMP -2400	-2450	-2755	-2770	-2785	UNIT	TEST CONDITIONS
Luminous Intensity	min.	I_V	6	13	13	13	26	mcd	I_F=20 mA
	typ.		20	38	35	35	70	mcd	I_F=20 mA
	typ.		33	60	60	60	115	mcd	I_F=60 mA pK, 1:3 D.F.
Forward voltage	max.	V_F	2.6	2.6	2.6	2.6	2.6	V	I_F=20 mA
	typ.		2.1	2.1	2.1	2.1	2.1		
Peak wavelength	typ.	λ_p	585	585	585	585	585	nm	
Dominant wavelength	typ.	λ_d	588	588	588	588	588	nm	
Capacitance	typ.	C	35	35	35	35	35	pF	V_F=0, f=1 MHz
Reverse voltage	min.	V_R	6	6	6	6	6	V	I_R=100 μA
Thermal resistance	typ.	θ_{JL}	150	150	150	150	150	°C/W/ LED chip	

ELECTRO-OPTICAL CHARACTERISTICS (T_A=25°C)
HIGH EFFICIENCY GREEN

PARAMETER		SYMBOL	HLMP -2500	-2550	-2855	-2870	-2885	UNIT	TEST CONDITIONS
Luminous Intensity	min.	I_V	5	11	11	11	22	mcd	I_F=20 mA
	typ.		25	50	50	50	100	mcd	I_F=20 mA
	typ.		38	75	75	75	150	mcd	I_F=60 mA pK, 1:3 D.F.
Forward voltage	max.	V_F	2.6	2.6	2.6	2.6	2.6	V	I_F=20 mA
	typ.		2.2	2.2	2.2	2.2	2.2		
Peak wavelength	typ.	λ_p	565	565	565	565	565	nm	
Dominant wavelength	typ.	λ_d	567	567	567	567	567	nm	
Capacitance	typ.	C	40	40	40	40	40	pF	V_F=0, f=1 MHz
Reverse voltage	min.	V_R	6	6	6	6	6	V	I_R=100 μA
Thermal resistance	typ.	θ_{JL}	150	150	150	150	150	°C/W/ LED chip	

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

(25°C Free Air Temperature Unless Otherwise Specified)

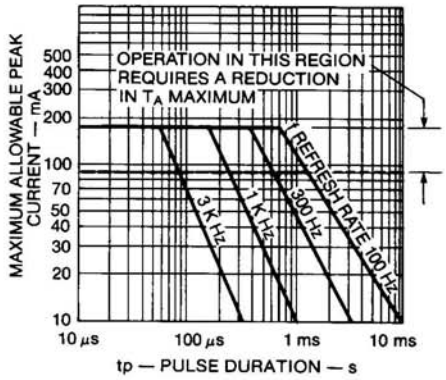


Fig. 1. Maximum Tolerable Peak Current per LED Chip vs. Pulse Duration for HLMP-23X0/-26XX/-25X0/-28XX

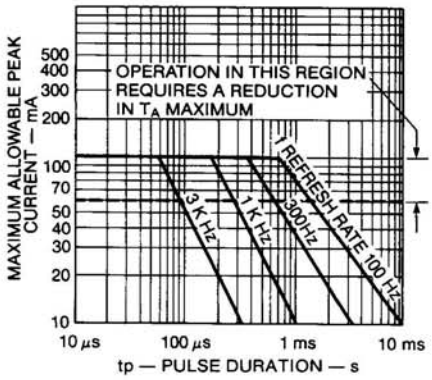


Fig. 2. Maximum Tolerable Peak Current per LED Chip vs.Pulse Duration for HLMP-24X0/-27XX Devices

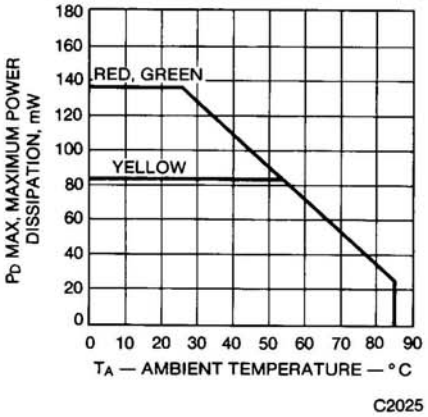


Fig. 3. Maximum Power Dissipation per LED vs. Ambient Temperature

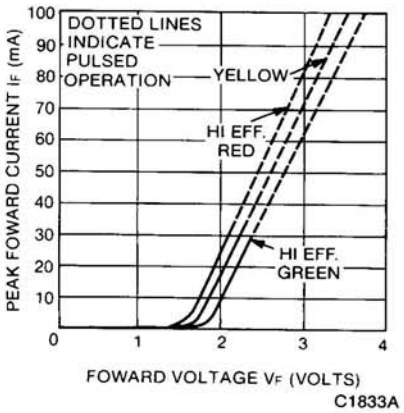


Fig. 4. Forward Current vs. Forward Voltage

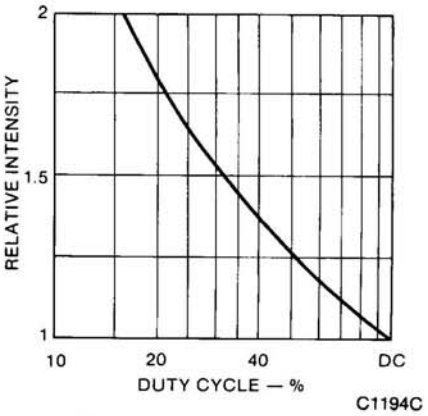


Fig. 5. Luminous Intensity vs. Duty Cycle

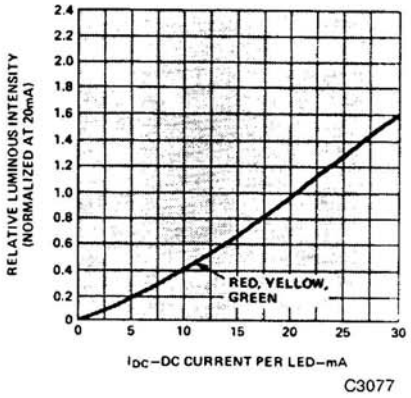


Fig. 6. Luminous Intensity vs. Forward Current

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

(25°C Free Air Temperature Unless Otherwise Specified) (Cont'd)

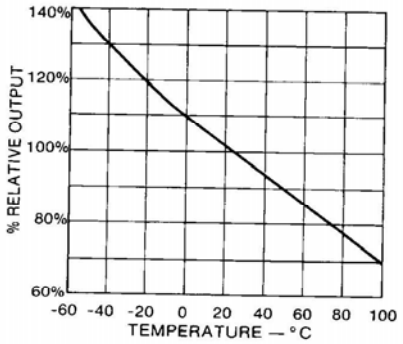
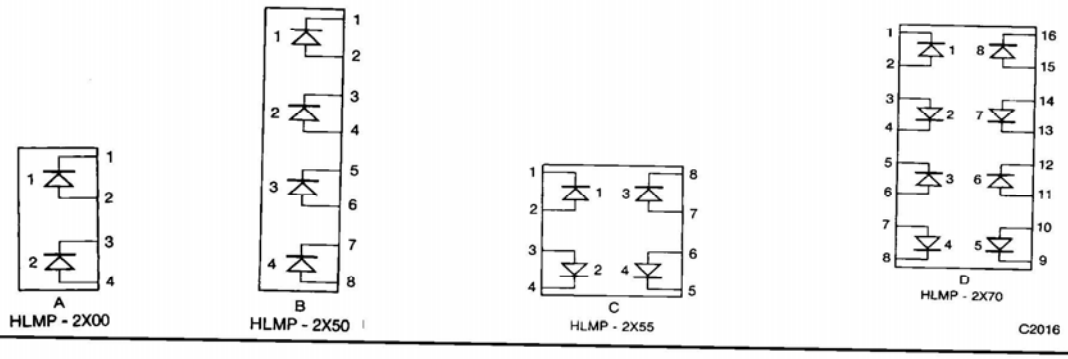


Fig. 7. Output vs. Temperature

PIN CONNECTIONS TO ELECTRICAL SCHEMATIC

PIN	ELECTRICAL CONNECTION			
	HLMP-2X00	HLMP-2X50	HLMP-2X55	HLMP-2X70/-2X85
1	1 Cathode	1 Cathode	1 Cathode	1 Cathode
2	1 Anode	1 Anode	1 Anode	1 Anode
3	2 Cathode	2 Cathode	2 Anode	2 Anode
4	2 Anode	2 Anode	2 Cathode	2 Cathode
5		3 Cathode	3 Cathode	3 Cathode
6		3 Anode	3 Anode	3 Anode
7		4 Cathode	4 Anode	4 Anode
8		4 Anode	4 Cathode	4 Cathode
9				5 Cathode
10				5 Anode
11				6 Anode
12				6 Cathode
13				7 Cathode
14				7 Anode
15				8 Anode
16				8 Cathode

ELECTRICAL SCHEMATIC



DISCLAIMER
FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN;NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY
FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be or (b) reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

© 2006 Everlight Electronics Co., Ltd